

1 2 3 4 5 6 7 8

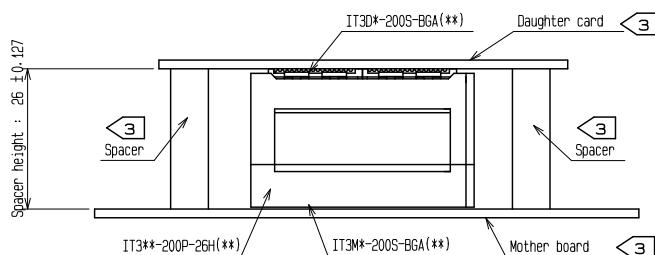
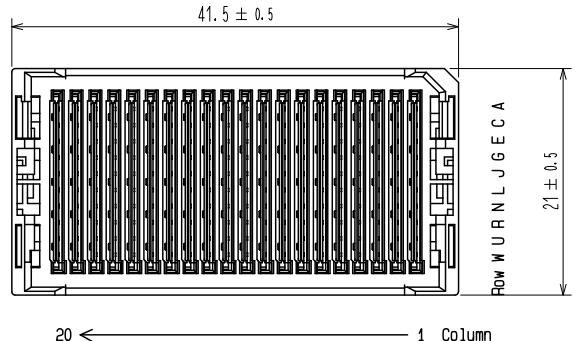
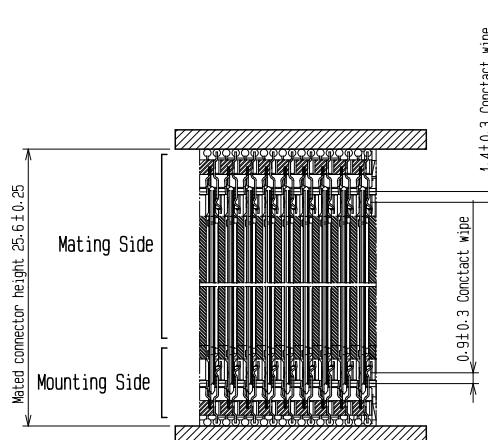
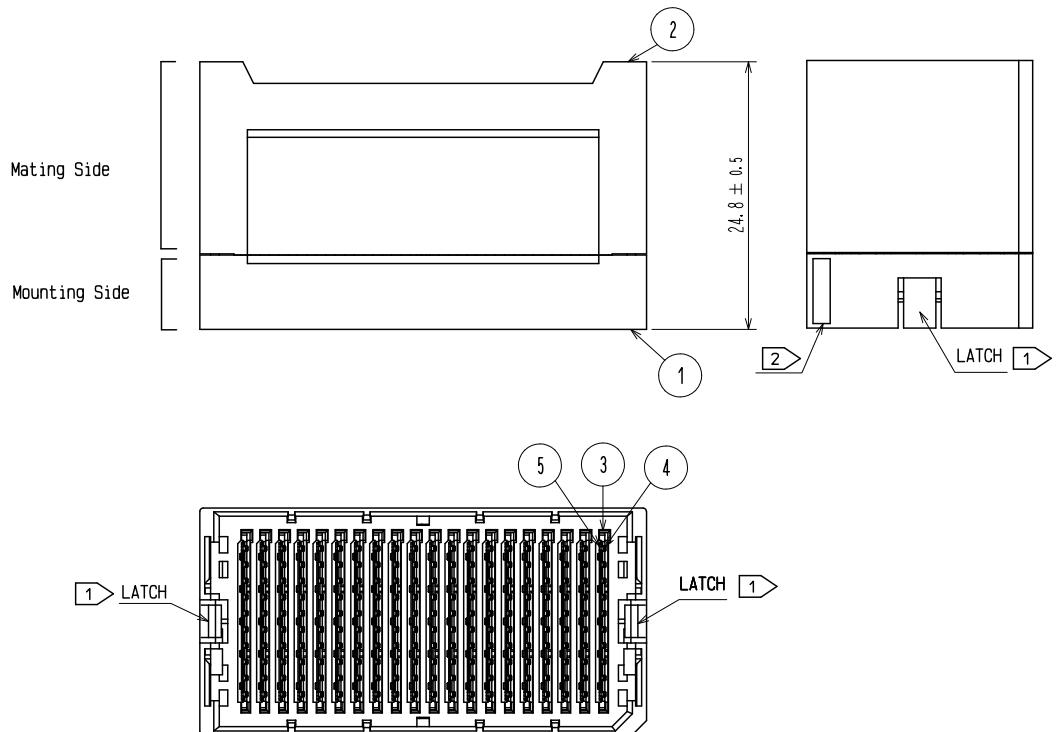


Fig.1(FREE)



Mating Cross Section (Free)

NOTE.

- 1) Mounting side is mated with the receptacle:IT3M-200S-BGA(**) and fixed with the latch.
- 2) Lot No. shall be marked on the indicated position.
- 3) The indicated mother board and daughter card shall be fastened to the additional reinforcements to prevent the stress on IT3M-200S-BGA(**) solder joints.
- 4) More information of this product is available in HIROSE document :ETAD-F0347 "IT3 design guideline".
- 5) This product consists of 200 signal lines and 180 ground lines.
- 6) 40pcs of this products are packed in a soft tray.
- 7) Standard package of 80pcs are packaged in a carton box.

NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS
3	PC	BLACK	UL94V-0	5	Copper Alloy	CONTACT AREA:NICKEL(1.5μm)+GOLD (0.76μm)	
2	PBT	GRAY	UL94V-0	4	Copper Alloy	CONTACT AREA:NICKEL(1.5μm)+GOLD (0.76μm)	
1	PBT	BLACK	UL94V-0				
UNITS mm		SCALE 2 : 1	REV COUNT 1	DESCRIPTION OF REVISIONS DIS-F-004000	DESIGNED TK.KIKUCHI	CHECKED TM.MATSUO	DATE 09.07.17
APPROVED : T. MATSUO 06/20/2008 DRAWING NO. EDC-157066-01							
CHECKED : T. MATSUO 06/20/2008 PART NO. IT3-200P-26H(03)							
DESIGNED : M. NAGATA 06/20/2008 CODE NO. CL636-0110-8-03							
DRAWN : M. NAGATA 06/20/2008							

HRS
HIROSE
ELECTRIC
CO., LTD.